



# ENZOTECH Enzotech MST-66 Forged Copper Mosfet Heatsink

\$14.95

## Product Images



## Short Description

### Product Details:

ENZOTECH MST-66 heatsink was designed to offer exceptional heat dissipation for integrated MOSFET motherboard cards. MST-66 heatsink is made using a forged copper process which produces a dense material that is extremely efficient at heat extraction. The MST-66 heatsink is far superior to traditional heat sinks currently found on the market and it provides the best thermal conductivity available to dissipate heat from the MOSFET in your system..

Specifications:



Dimensions (mm)	72(L) x 13(W) x 29.6(H)
Material	C1100 Forged Copper
Weight	55g
Thermal Adhesive	Fujipoly GR-d Thermal Tape
SUPPORTED MB	
GigaByte	EX58-UD5,EX58-UD4P,EX58-Extreme,GA-P35-DS3P,GA-P35-DS4,GA-P35-DQ6,GA-EP45-DS3P,GA-EP45-DS4,GA-EP45-DS5,GA-EP45-DQ6,GA-EP45-Extreme,GA-EP45T-Extreme

## Description

---

### Product Details:

ENZOTECH MST-66 heatsink was designed to offer exceptional heat dissipation for integrated MOSFET motherboards cards. MST-66 heatsink is made using a forged copper process which produces a dense material that is extremely efficient at heat extraction. The MST-66 heatsink is far superior to traditional heat sinks currently found on the market and it provides the best thermal conductivity available to dissipate heat from the MOSFET in your system..

Specifications:



Dimensions (mm)	72(L) x 13(W) x 29.6(H)
Material	C1100 Forged Copper
Weight	55g
Thermal Adhesive	Fujipoly GR-d Thermal Tape
SUPPORTED MB	
GigaByte	EX58-UD5,EX58-UD4P,EX58-Extreme,GA-P35-DS3P,GA-P35-DS4,GA-P35-DQ6,GA-EP45-DS3P,GA-EP45-DS4,GA-EP45-DS5,GA-EP45-DQ6,GA-EP45-Extreme,GA-EP45T-Extreme

## Additional Information

---

Brand	Enzotech
SKU	MST-66
Weight	0.5000
Color	Copper
Material	Copper

